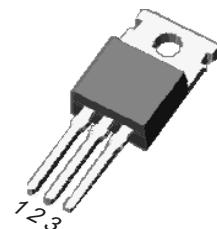


## Description

Glass passivated triacs in a plastic envelope, intended for use in applications requiring high bidirectional transient and blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

## Simplified outline

**TO-220**


## Features

- Blocking voltage to 600 V
- On-state RMS current to 6 A

## Symbol



## Applications

- Motor control
- Industrial and domestic lighting
- Heating
- Static switching

Pin	Description
1	Main terminal 1 (T1)
2	Main terminal 2 (T2)
3	gate (G)
TAB	Main terminal

SYMBOL	PARAMETER	Value	Unit
$V_{DRM}$	Repetitive peak off-state voltages	600	V
$I_T \text{ (RMS)}$	RMS on-state current (full sine wave)	6	A
$I_{TSM}$	Non-repetitive peak on-state current (full cycle, $T_j$ initial=25°C)	63	A

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
$R_{th(j-c)}$	Junction to case(AC)		-	1.8	-	°C/W
$R_{th(j-a)}$	Junction to ambient		-	60	-	°C/W

**Limiting values in accordance with the Maximum system(IEC 134)**

SYMBOL	PARAMETER	CONDITIONS			MIN	Value	UNIT
$V_{DRM}$	Repetitive peak off-state Voltages	$T_j=110^\circ C$			-	600	V
$I_{T(RMS)}$	RMS on-state current	$T_c=110^\circ C$			-	6	A
$I_{TSM}$	Non repetitive surge peak on-state current	$T_j$ initial = $25^\circ C$	$F=50Hz$	$t=20ms$	-	60	A
			$F=60Hz$	$t=16.7ms$	-	63	A
$I^2t$	$I^2t$ value for fusing	$T_p=10ms$			-	21	$A^2s$
$dI/dt$	Critical rate of rise of on-state current	$I_g=2 \times I_{GT}$ , $tr \leq 100ns$	$F=120Hz$	$T_j=125^\circ C$	-	50	$A/\mu s$
$I_{GM}$	Peak gate current	$T_p=20 \mu s$		$T_j=125^\circ C$	-	4	A
$I_{DRM}$	$V_{DRM}=V_{RRM}$			$T_j=25^\circ C$	-	5	$\mu A$
$I_{RRM}$	$V_{DRM}=V_{RRM}$			$T_j=125^\circ C$	-	1	mA
$P_{G(AV)}$	Average gate power			$T_j=125^\circ C$	-	1	W
$T_{stg}$	Storage temperature range			-40	150		$^\circ C$
$T_j$	Operating junction Temperature range			-40	125		$^\circ C$

 **$T_j=25^\circ C$  unless otherwise stated**

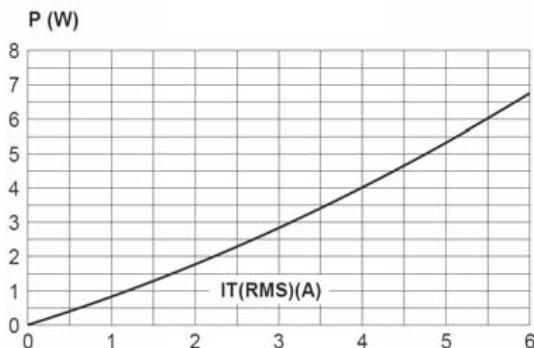
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Static characteristics						
$I_{GT}$		$V_D=12V; R_L=30\Omega$	I-II-III IV	-	-	50 100 mA mA
$I_L$		$I_g=1.2 I_{GT}$	I-III-IV II	-	-	50 100 mA mA
$I_H$		$I_T=500mA$	-	-	50	mA
$V_{GT}$		$V_D=12V; R_L=30\Omega$	ALL	-	-	1.3 V
$V_{GD}$		$V_D=V_{DRM} R_L=3.3K\Omega T_j=125^\circ C$	ALL	0.2	-	- V
$dV/dt$		$V_D=67\%V_{DRM}$ gate open; $T_j=125^\circ C$	400	-	-	$V/\mu s$
(dV/dt)c	$(dI/dt)c=2.7A/ms$	$T_j=125^\circ C$	10	-	-	$V/\mu s$

**Dynamic Characteristics**

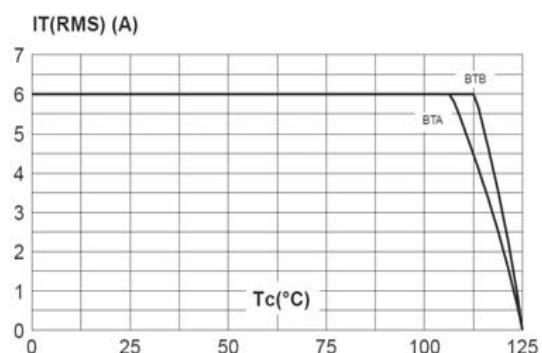
$V_{TM}$	$I_{TM}=5.5A$ tp=380us	$T_j=25^\circ C$	-	-	1.55	V
$V_{to}$	Threshold voltage	$T_j=125^\circ C$	-	-	0.85	V
$R_d$	Dynamic resistance	$T_j=125^\circ C$	-	-	60	$m\Omega$

## Description

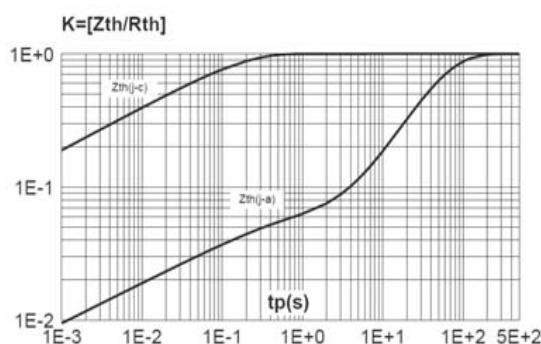
**Fig. 1:** Maximum power dissipation versus RMS on-state current (full cycle).



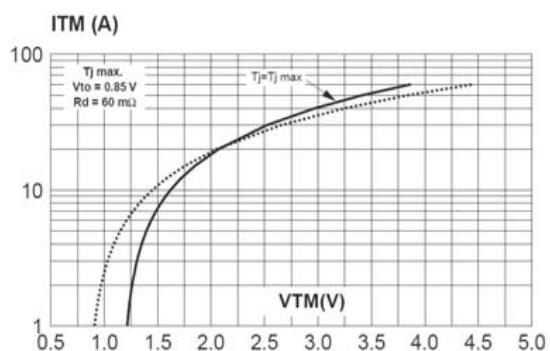
**Fig. 2:** RMS on-state current versus case temperature (full cycle).



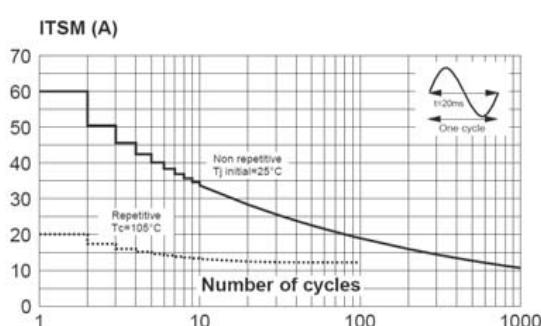
**Fig. 3:** Relative variation of thermal impedance versus pulse duration.



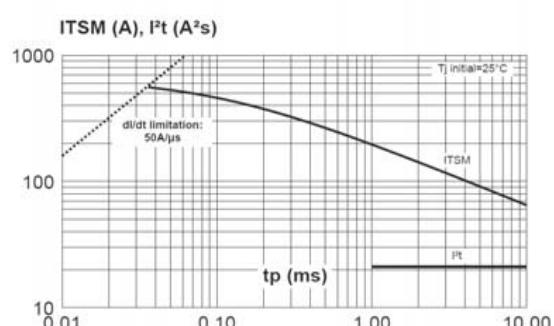
**Fig. 4:** On-state characteristics (maximum values).



**Fig. 5:** Surge peak on-state current versus number of cycles.

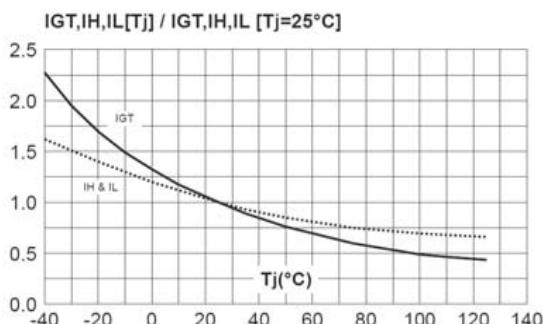


**Fig. 6:** Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp < 10ms, and corresponding value of I<sup>2</sup>t.

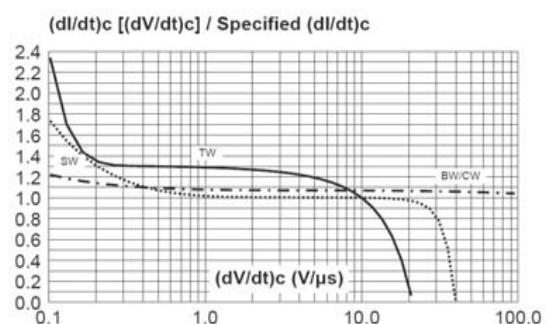


## Description

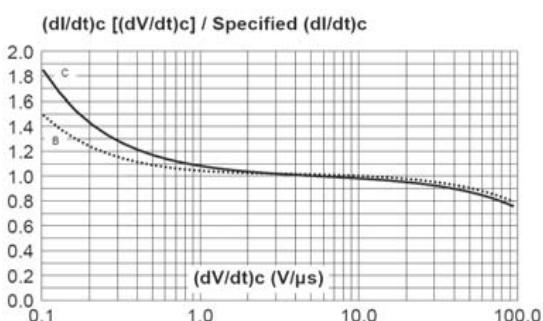
**Fig. 7:** Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values).



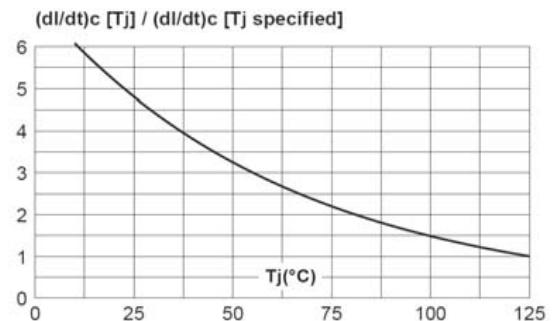
**Fig. 8-1:** Relative variation of critical rate of decrease of main current versus  $(dV/dt)c$  (typical values). Snubberless & Logic Level Types



**Fig. 8-2:** Relative variation of critical rate of decrease of main current versus  $(dV/dt)c$  (typical values). Standard Types

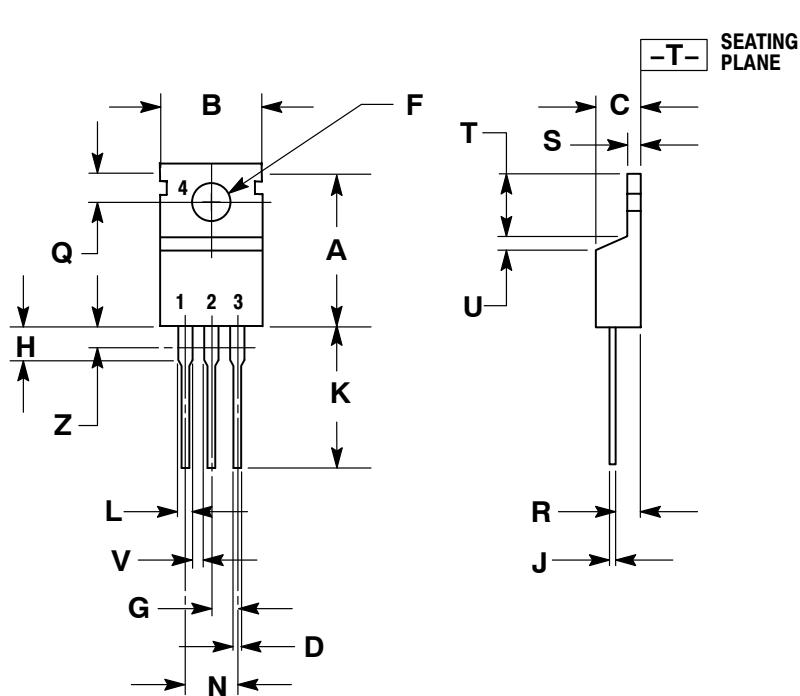


**Fig. 9:** Relative variation of critical rate of decrease of main current versus junction temperature.



## Package Dimensions

**TO-220**



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.161	3.61	4.09
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.014	0.025	0.36	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

STYLE 6:

1. ANODE
2. CATHODE
3. ANODE
4. CATHODE